

TECHNICAL REPORT

**Semiconductor converters – General requirements and line commutated converters –
Part 1-2: Application guide**

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

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CONTENTS

FOREWORD	8
1 Scope	10
2 Normative references	10
3 Terms and definitions	11
3.1 Terms and definitions related to converter faults	11
3.2 Terms and definitions related to converter generated transients.....	12
3.3 Terms and definitions related to temperature	13
4 Application of semiconductor power converters	13
4.1 Application	13
4.1.1 General	13
4.1.2 Conversion equipment and systems.....	14
4.1.3 Supply source conditioning (active and reactive power)	14
4.2 Equipment specification data	14
4.2.1 Main items on the specification	14
4.2.2 Terminal markings	14
4.2.3 Additional information	15
4.2.4 Unusual service conditions	16
4.3 Converter transformers and reactors.....	16
4.4 Calculation factors	16
4.4.1 General	16
4.4.2 Voltage ratios	21
4.4.3 Line side transformer current factor	21
4.4.4 Valve-side transformer current factor	21
4.4.5 Inductive direct voltage regulation due to transformer	22
4.4.6 Magnetic circuit	22
4.4.7 Transformer guaranteed load losses	22
4.4.8 Transformer guaranteed short-circuit impedance	22
4.4.9 Line side fundamental current factor	22
4.5 Parallel and series connections.....	23
4.5.1 Parallel or series connection of valve devices	23
4.5.2 Parallel or series connection of assemblies and equipment units	23
4.6 Power factor	24
4.6.1 General	24
4.6.2 Symbols used in the determination of displacement factor	24
4.6.3 Circle diagram for the approximation of the displacement factor $\cos\varphi_{1N}$ and of the reactive power Q_{1LN} for rectifier and inverter operation.....	26
4.6.4 Calculation of the displacement factor $\cos\varphi_1$	26
4.6.5 Conversion factor	28
4.7 Direct voltage regulation	28
4.7.1 General	28
4.7.2 Inherent direct voltage regulation.....	29
4.7.3 Direct voltage regulation due to AC system impedance.....	33
4.7.4 Information to be exchanged between supplier and purchaser about direct voltage regulation of the converter	35
4.8 Voltage limits for reliable commutation in inverter mode.....	36
4.9 AC voltage waveform	36

5	Application information	37
5.1	Practical calculation of the operating parameters	37
5.1.1	General	37
5.1.2	Assumptions	38
5.1.3	Preliminary calculations	38
5.1.4	Calculation of the operating conditions	39
5.2	Supply system voltage change due to converter loads	41
5.2.1	Fundamental voltage change	41
5.2.2	Minimum R_{1SC} requirements for voltage change	41
5.2.3	Converter transformer ratio	41
5.2.4	Transformer rating	42
5.3	Compensation of converter reactive power consumption	43
5.3.1	Average reactive power consumption	43
5.3.2	Required compensation of the average reactive power	43
5.3.3	Voltage fluctuations with fixed reactive power compensation	44
5.4	Supply voltage distortion	45
5.4.1	Commutation notches	45
5.4.2	Operation of several converters on the same supply line	47
5.5	Quantities on the line side	48
5.5.1	RMS value of the line current	48
5.5.2	Harmonics on the line side, approximate method for 6-pulse converters	48
5.5.3	Minimum R_{1SC} requirements for harmonic distortion	51
5.5.4	Estimated phase shift of the harmonic currents	52
5.5.5	Addition of harmonic currents	52
5.5.6	Peak and average harmonic spectrum	52
5.5.7	Transformer phase shift	53
5.5.8	Sequential gating, two 6-pulse converters	53
5.6	Power factor compensation and harmonic distortion	54
5.6.1	General	54
5.6.2	Resonant frequency	54
5.6.3	Directly connected capacitor bank	54
5.6.4	Estimation of the resonant frequency	54
5.6.5	Detuning reactor	56
5.6.6	Ripple control frequencies (carrier frequencies)	57
5.7	Direct voltage harmonic content	57
5.8	Other considerations	58
5.8.1	Random control angle	58
5.8.2	Sub-harmonic instability	58
5.8.3	Harmonic filters	59
5.8.4	Approximate capacitance of cables	59
5.9	Calculation of DC short-circuit current of converters	59
5.10	Guidelines for the selection of the immunity class	59
5.10.1	General	59
5.10.2	Converter Immunity class	60
5.10.3	Selection of the immunity class	60
6	Test requirements	63
6.1	Guidance on power loss evaluation by short-circuit test	63
6.1.1	Single-phase connections	63
6.1.2	Polyphase double-way connections	64

6.1.3	Polyphase single-way connections	64
6.2	Procedure for evaluation of power losses by short-circuit method	64
6.3	Test methods	65
6.3.1	Method A1	65
6.3.2	Method B	66
6.3.3	Method C	66
6.3.4	Method D	66
6.3.5	Method E	69
6.3.6	Method A2	69
7	Performance requirements	69
7.1	Presentation of rated peak load current values	69
7.2	Letter symbols related to virtual junction temperature	70
7.3	Determination of peak load capability through calculation of the virtual junction temperature	71
7.3.1	General	71
7.3.2	Approximation of the shape of power pulses applied to the semiconductor devices	72
7.3.3	The superposition method for calculation of temperature	73
7.3.4	Calculation of the virtual junction temperature for continuous load	74
7.3.5	Calculation of the virtual junction temperature for cyclic loads	75
7.3.6	Calculation of the virtual junction temperature for a few typical applications	76
7.4	Circuit operating conditions affecting the voltage applied across converter valve devices	76
8	Converter operation	77
8.1	Stabilization	77
8.2	Static properties	77
8.3	Dynamic properties of the control system	78
8.4	Mode of operation of single and double converters	78
8.4.1	Single converter connection	78
8.4.2	Double converter connections and limits for rectifier and inverter operation	80
8.5	Transition current	81
8.6	Suppression of direct current circulation in double converter connections	82
8.6.1	General	82
8.6.2	Limitation of delay angles	82
8.6.3	Controlled circulating current	82
8.6.4	Blocking of trigger pulses	82
8.7	Principle of operation for reversible converters for control of DC motors	83
8.7.1	General	83
8.7.2	Motor field reversal	83
8.7.3	Motor armature reversal by reversing switch	83
8.7.4	Double converter connection to motor armature	83
9	Converter faults	84
9.1	General	84
9.2	Fault finding	85
9.3	Protection from fault currents	85
Annex A (informative)	Information on converter transformer standards	86
A.1	Background	86

A.1.1	General	86
A.1.2	Structure of IEC 61378 (all parts)	86
A.2	Important difference between IEC 61378 (all parts) and IEC 60146 (all parts).....	86
A.3	Coordination between transformer and power converter.....	87
Annex B (informative)	Application guide for the protection of semiconductor converters against overcurrent by fuses	88
B.1	Object.....	88
B.2	Fuse connections in converter	88
B.2.1	General	88
B.2.2	Double way connection.....	88
B.2.3	Single-way connection (B), regenerative or non-regenerative load.....	90
B.3	Main parameters to be considered for fuse selection.....	90
B.4	Applied voltage in service	91
B.5	Discrimination for fuses in parallel connection.....	91
B.5.1	Discrimination between paralleled fuses and circuit breaker	91
B.5.2	Discrimination among paralleled fuses.....	92
B.5.3	Protection of semiconductor against overcurrent.....	93
B.6	General considerations	93
Annex C (informative)	Inductive voltage regulation due to converter transformer	94
C.1	General.....	94
C.2	Recommendation for calculating inductive voltage regulation due to converter transformer.....	94
C.3	Inductive voltage regulation	94
C.3.1	DC output voltage during commutation	94
C.3.2	DC voltage regulation	95
C.3.3	Formula of inductive voltage regulation due to converter transformer.....	96
C.4	Analysis of ratio (d_{xtN}/e_{xN})	96
C.4.1	General	96
C.4.2	Base impedance of converter transformer.....	97
C.4.3	Relationship between transformer reactance X_t and parameter e_{xN}	97
C.4.4	Derivation of ratio (d_{xtN}/e_{xN})	98
C.5	Implicit assumptions implemented in ratio (d_{xtN}/e_{xN})	98
C.6	Old calculation factors for information	99
C.7	Inductive voltage regulation including the system reactances.....	100
Bibliography	104
Figure 1	– Voltages at converter faults.....	11
Figure 2	– Circle diagram for approximation of the displacement factor.....	26
Figure 3	– Displacement factor as a function of d_{xN} for $p = 6$	27
Figure 4	– Displacement factor as a function of d_{xN} for $p = 12$	28
Figure 5	– d_{LN} as a function of d_{xN} for $p = 6$ and $p = 12$	34
Figure 6	– AC voltage waveform	37
Figure 7	– Harmonic current spectrum on the AC side for $p = 6$	50
Figure 8	– Influence of capacitor rating and AC motor loads on the resonant frequency and amplification factor.....	55
Figure 9	– Direct voltage harmonic content for $p = 6$	58
Figure 10	– Example of power distribution	61
Figure 11	– Test method A1.....	65

Figure 12 – Test method D	67
Figure 13 – Single peak load	70
Figure 14 – Repetitive peak loads	70
Figure 15 – Approximation of the shape of power pulses	73
Figure 16 – Calculation of the virtual junction temperature for continuous load	74
Figure 17 – Calculation of the virtual junction temperature for cyclic loads	75
Figure 18 – Circuit operating conditions affecting the voltage applied across converter valve devices	77
Figure 19 – Direct voltage waveform for various delay angles	79
Figure 20 – Direct voltage for various loads and delay angles	80
Figure 21 – Direct voltage limits in inverter operation	81
Figure 22 – Direct voltage at values below the transition current	82
Figure 23 – Operating sequences of converters serving a reversible DC motor	84
Figure B.1 – Three-phase double-way connection with diodes or thyristors with AC side fuses F_V for non-regenerative load	89
Figure B.2 – Three phase double-way connection with AC side fuses F_V and DC side fuse F_D for regenerative load	89
Figure B.3 – Three-phase double-way connection with arm fuses F_a for regenerative or non-regenerative load	90
Figure B.4 – Double three-phase single-way connection with interphase transformer, with arm fuses F_a for regenerative or non-regenerative load	90
Figure B.5 – Arc voltage	91
Figure C.1 – Three-phase bridge converter	95
Figure C.2 – Voltage regulation	96
Table 1 – Connections and calculation factors (1 of 4)	17
Table 2 – List of symbols used in the determination of displacement factor	25
Table 3 – List of symbols used in the calculation formulae	32
Table 4 – Example of operating conditions	40
Table 5 – Example of operating points	40
Table 6 – Example of operating conditions	42
Table 7 – Result of the iteration	42
Table 8 – Example of calculation results of active and reactive power consumption	43
Table 9 – Example of notch depth	46
Table 10 – Example of notch depth by one converter with a common transformer	47
Table 11 – Example of notch depth by ten converters operating at the same time	47
Table 12 – Values of $I_L^*(\alpha, \mu)/I_L$	48
Table 13 – Minimum R_{1SC} requirement for low voltage systems	52
Table 14 – Transformer phase shift and harmonic orders	53
Table 15 – Approximate kvar/km of cables	59
Table 16 – Short-circuit values of converter currents	59
Table 17 – Calculated values for the example in Figure 10	63
Table 18 – Letter symbols related to virtual junction temperature	71
Table 19 – Virtual junction temperature	76

Table C.1 – Columns from 12 to 15 and 17 in Table 1 of IEC 60146-1-2:2011 or older editions (1 of 2)..... 99

INTERNATIONAL ELECTROTECHNICAL COMMISSION

SEMICONDUCTOR CONVERTERS – GENERAL REQUIREMENTS AND LINE COMMUTATED CONVERTERS –

Part 1-2: Application guidelines

FOREWORD

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The main task of IEC technical committees is to prepare International Standards. However, a technical committee may propose the publication of a Technical Report when it has collected data of a different kind from that which is normally published as an International Standard, for example "state of the art".

IEC TR 60146-1-2, which is a Technical Report, has been prepared by IEC technical committee 22: Power electronic systems and equipment.

This fifth edition cancels and replaces the fourth edition published in 2011. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) addition of annexes concerning the applications of converter transformers and of fuses for overcurrent protection;

- b) changes of calculation methods related the inductive voltage regulation and changes of description on transformer losses to be consistent with the latest transformer standards;
- c) addition and updates of references based on the latest information.

The text of this Technical Report is based on the following documents:

Draft T	Report on voting
22/306/DTR	22/310/RVDTR

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 60146 series, under the general title *Semiconductor converters – General requirements and line commutated converters*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this standard may be issued at a later date.

SEMICONDUCTOR CONVERTERS – GENERAL REQUIREMENTS AND LINE COMMUTATED CONVERTERS –

Part 1-2: Application guidelines

1 Scope

This part of IEC 60146, which is a Technical Report, gives guidance on variations to the specifications given in IEC 60146-1-1:2009 to enable the specification to be extended in a controlled form for special cases. Background information is also given on technical points, which facilitates the use of IEC 60146-1-1:2009.

This document primarily covers line commutated converters and is not in itself a specification, except as regards certain auxiliary components, in so far as existing standards may not provide the necessary data.

This document will not take precedence on any product specific standard according to the concept shown in IEC Guide 108. IEC Guide 108 provides the information on the relationship between horizontal standards and product publications.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60050-551, *International Electrotechnical Vocabulary – Part 551: Power electronics* (available at www.electropedia.org)

IEC 60050-551-20, *International Electrotechnical Vocabulary – Part 551-20: Power electronics – Harmonic analysis* (available at www.electropedia.org)

IEC 60146-1-1:2009, *Semiconductor converters – General requirements and line commutated converters – Part 1-1: Specification of basic requirements*

IEC 60269-1:2006, *Low-voltage fuses – Part 1: General requirements*

IEC 60269-4:2009, *Low-voltage fuses – Part 4: Supplementary requirements for fuse-links for the protection of semiconductor devices*

IEC 60529, *Degrees of protection provided by enclosures (IP Code)*

IEC 60664-1, *Insulation coordination for equipment within low-voltage systems – Part 1: Principles, requirements and tests*

IEC 61148, *Terminal markings for valve device stacks and assemblies and for power conversion equipment*

IEC 61378-1:2011, *Converter transformers – Part 1: Transformers for industrial applications*

